

2.0A Surface Mount Schottky Barrier Rectifiers - 20V-200V

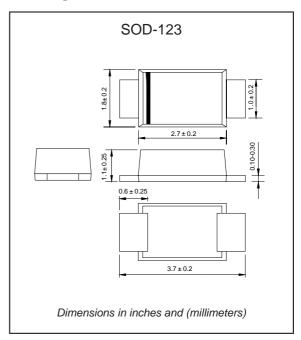
Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction, majority carrier conduction
- ◆ Low power loss,high efficiency
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 260℃/10 seconds
- ◆ Compliant to RoHS Directive 2011/65/EU
- ◆ Compliant to Halogen-free

Mechanical data

- ◆ Case: JEDEC SOD-123 molded plastic body
- ◆ Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- ◆ Mounting Position: Any

Package outline



Maximum ratings and Electrical Characteristics (AT T_A=25°C unless otherwise noted)

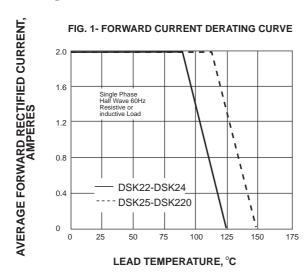
PARAMETER	SYMBOLS	DSK22	DSK23	DSK24	DSK25	DSK26	DSK28	DSK210	DSK215	DSK220	UNITS
Maximum repetitive peak reverse voltage	Vrrm	20	30	40	50	60	80	100	150	200	V
Maximum RMS voltage	VRMS	14	21	28	35	42	56	70	105	140	V
Maximum DC blocking voltage	VDC	20	30	40	50	60	80	100	150	200	V
Maximum average forward rectified current		2.0									
at TL(see fig.1)	l(AV)	2.0							A		
Peak forward surge current											
8.3ms single half sine-wave superimposed on	Ігѕм	45.0							Α		
rated load											
Maximum instantaneous forward voltage at 2.0A	VF		0.55		0.	70	().85	0.	92	V
Maximum DC reverse current Ta=25°C	0.5						mA				
at rated DC blocking voltage Ta=100℃	l _R	10.0				5	5.0 2.0)		
Typical junction capacitance (NOTE 1)	Cı	220 p				pF					
Typical thermal resistance (NOTE 2)	RθJA	85 °C			°C/W						
Operating junction temperature range	mperature range T _J , -55 to +125 -55 to +150			°C							
Storage temperature range	Тѕтс	-55 to +150			°C						

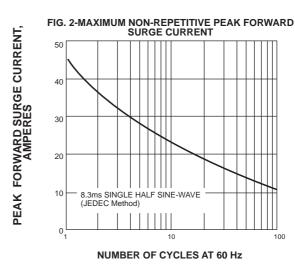
Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C. 2.P.C.B. mounted with 2.0x2.0"(5.0x5.0cm) copper pad areas

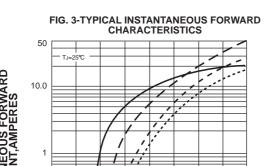


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Rating and characteristic curves

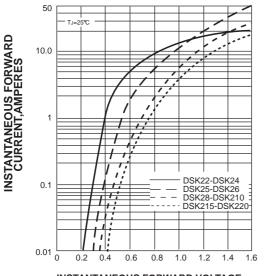


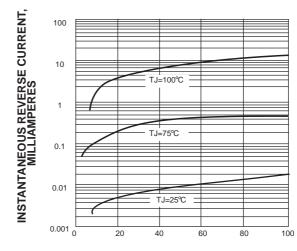






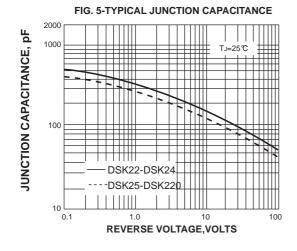
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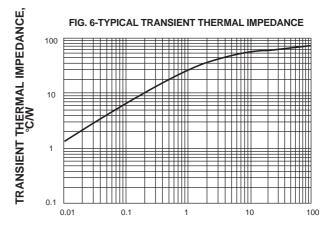




INSTANTANEOUS FORWARD VOLTAGE, VOLTS

PERCENT OF PEAK REVERSE VOLTAGE,%







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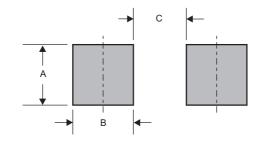
Pinning information

Pin	Simplified outline	Symbol		
Pin1 cathode Pin2 anode	1 2	1 2		

Marking

Type number	Marking code
DSK22 DSK23	K22 K23
DSK24	K24
DSK25	K25
DSK26	K26
DSK28	K28
DSK210	K210
DSK215	K215
DSK220	K220

Suggested solder pad layout



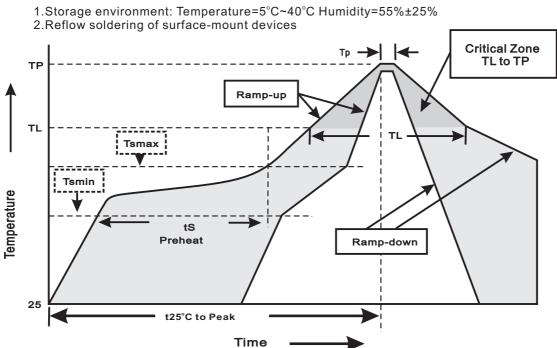
Dimensions in inches and (millimeters)

PACKAGE	Α	В	С		
SOD-123	0.075 (1.90)	0.055 (1.40)	0.075 (1.90)		



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Suggested thermal profiles for soldering processes



3.Reflow soldering

Profile Feature	Soldering Condition		
Average ramp-up rate(T∟ to T _P)	<3°C/sec		
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(t _s)	150°C 200°C 60~120sec		
Tsmax to T∟ -Ramp-upRate	<3°C/sec		
Time maintained above: -Temperature(TL) -Time(tL)	217°C 60~260sec		
Peak Temperature(T _P)	255°C-0/+5°C		
Time within 5°C of actual Peak Temperature(t _P)	10~30sec		
Ramp-down Rate	<6°C/sec		
Time 25°C to Peak Temperature	<6minutes		